

**IN THE CLAIMS:**

Please rewrite claims 1 and 18, as set forth below in clean form. Additionally, in accordance with 37 CFR 1.121 (c)(1)(ii), amended claims 1 and 18 is set forth in a Marked Up Version in the pages attached to this amendment.

B1  
GSM  
E1

1. (Twice Amended) A method for non-destructively evaluating a specimen for the presence of kissing unbond defects, comprising the steps of:  
heating the specimen;  
applying a force to the specimen, wherein the magnitude of the force is sufficient to exacerbate a thermal discontinuity caused by a purely subsurface kissing unbond defect of said specimen; and  
generating an infrared image to detect the presence of a purely subsurface kissing unbond defect.

B2  
GSM  
GSM

18. (Twice Amended) An apparatus for non-destructively evaluating a specimen for the presence of kissing unbond defects comprising:  
a heat-sensitive image generator that generates thermographic images;  
a heater that increases the temperature of the specimen; and  
means for applying a force to the specimen, wherein the applying means changes at least one dimension of a purely subsurface kissing unbond defect in the specimen to create a thermal discontinuity.

Please add the following new claim.

R1126 2/24 (New) A method for non-destructively evaluating a specimen for the presence of kissing unbond defects, comprising the steps of:  
heating the specimen;  
applying a force to the specimen, wherein the magnitude of the force is sufficient to exacerbate a thermal discontinuity caused by a purely subsurface kissing unbond defect of said specimen; and

B3  
Lentil  
GSM